## We claim:

1. A switch mode power supply, comprising:

a switching transistor having a load path formed by a first main connection and a second main connection, said first main connection and said second main connection for receiving a voltage applied thereto, said switching transistor including a semiconductor body with a semiconductor layer of a first conductance type forming a drift area;

a load connected in series with said load path of said switching transistor;

a continuous drain region of a second conductance type incorporated into said drift area and connected to said first main connection;

a continuous source region of the second conductance type incorporated into said drift area and connected to said second main connection;

a reverse-biased pn-junction produced by an interaction between said semiconductor body and said continuous drain region and between said semiconductor body and said continuous source region;

said reverse-biased pn-junction having a large inner voltagedependent surface area that is variable as a function of the voltage applied to said first main connection and said second main connection;

when the voltage applied is 10 V, said switching transistor is characterized by a first product of a switch-on resistance  $R_{\text{on}}$  and a gate charge  $Q_{\text{gtot}}$ , the first product given by:

 $R_{on} * Q_{qtot}/10 V \le 2.5 ns;$  and

when the voltage applied is 400 V, said switching transistor is characterized by a second product of the switch-on resistance  $R_{on}$  and energy  $E_{ds}$  stored in a drain-source capacitance, the second product given by  $R_{on}$  \*  $E_{ds} \leq$  1.6  $V^2\mu s$ .

- 2. The switch mode power supply according to claim 1, wherein said voltage-dependent surface area of said pn-junction is reduced as the voltage applied is increased.
- 3. The switch mode power supply according to claim 2, wherein an amount of charge in said switching transistor, which is calculated via a line integral along a line at right angles to said pn-junction, remains below a material-specific breakdown charge.

- 4. The switching transistor according to claim 3, wherein said continuous drain region of said second conductance type and said continuous source region of said second conductance type are configured in a structure selected from the group consisting of a vertical structure and a lateral structure.
- 5. The switch mode power supply according to claim 1, comprising a charge storage device connected in parallel with said load path of said switching transistor.